



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Chuen Rong Leu et al.
Assignee: Bridge Semiconductor Corporation
Title: SEMICONDUCTOR CHIP ASSEMBLY WITH EMBEDDED METAL PILLAR
Serial No.: 10/714,794 Filed: November 17, 2003
Examiner: Williams, A. Group Art Unit: 2826
Atty. Docket No.: BDG024

COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

In response to the Office Action dated October 26, 2005, please amend the application as follows.

The Specification Amendments begin at page 2.

The Claim Amendments begin at page 4.

The Remarks begin at page 22.